



Product Change Notification

Change Notification #: 118984-00
Change Title: Select Intel® SSD DC P4511 Series SKUs,
PCN 118984-00, Product Discontinuance,
End of Life
Date of Publication: March 24, 2022

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Last Product Discontinuance Order Date	July 29, 2022
Last Product Discontinuance Shipment Date	November 30, 2022

Description of Change to the Customer:

The Intel SKUs listed in the products affected table will End of life.

Solidigm™ DC P4511 (formerly Intel® SSD DC P4511)

End of Life Notification: Mar 2022

Last Time Order Date: Jul 2022

Last Time Shipment: Nov 2022

Transition Recommendations:

Please contact your Solidigm representative for Solidigm™ DC P4511 M.2 (formerly Intel® SSD DC P4511) follow on products.

Customer Impact of Change and Recommended Action:

Please determine your remaining demand for the products listed in the "Products Affected/Intel Ordering Codes" table and place your "Last Product Discontinuance Order" in accordance with the "Key Milestones" listed above.

Please contact your local Intel Field Sales representative if you have any further questions about this End of Life notice.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	Affected MM#
Intel® SSD DC P4511 Series (1.0TB, M.2 110mm PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPELKX010T801	965843
Intel® SSD DC P4511 Series (2.0TB, M.2 110mm PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPELKX020T801	965844

PCN Revision History:

Date of Revision:

March 24, 2022

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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